

Datasheet revision 1.0 www.chipquik.com

RA Rosin Paste Flux in 50 gram Jar

Product Highlights

Ideal for all rework, solder, de-solder and wire dipping applications Easily cleaned with Flux Remover or isopropyl alcohol (IPA) Designed for Leaded and Lead-Free applications

RoHS 3 and REACH compliant



Flux Type: Rosin Activated (for Leaded and Lead-Free applications)

Flux Classification: ROM1 (Must be cleaned off post-use using Flux Remover or IPA)

Packaging: Jar 50g

Shelf Life: Refrigerated >36 months, Unrefrigerated >36 months

Stencil Life

>8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using flux remover or isopropyl alcohol (IPA).

Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes):

Yes

RoHS 2 Directive 2011/65/EU:

Yes